

PTC

Product Class	5 Telecom Pair Protection B594/5/6/7/8xxT* 14.10.2019 5.04							
Date								
IMDS ID if available								
Version								
Product Part (IMDS: semi component)	Material Class (IMDS: Material)	Material (Classification) VDA 231	Substance	TMPS**) [wt%]	CAS if applicable	typical mass of material [wt-%]	Traces see 1)	
Active Part	Ceramic	3B	Ba-titanates Pb-titanates Sr-titanates Ca-titanates others*)	69 15 10 5 1	12047-27-7 12060-00-3 12060-59-2 12049-50-2	55.9		
Termination	Noble Metal Heavy Metal	1D7 1C14	Ag Ni	100 100	7440-22-4 7440-02-0	0.046		
Solder	Heavy Metal Heavy Metal	1C2 1C15	Cr Pb +) Sn Ag	100 93 5 2	7440-47-3 7439-92-1 7440-31-5 7440-22-4	0.024		
Leads	Heavy Metal Heavy Metal	1C12 1C8	Cu Sn	100 100	7440-50-8 7440-31-5	4.8 0.2		
Housing	Thermoplastic	2A	LC-Polymer	100	90967-43-4	36		
					Sum of total	100		
weight range [g] 2.15 0.9 1.5 1.7 1.7 1.9 Not part of a Product (material numbers B594xxT1* B595xxT1xxxA262 B595xxT1xxxA62 B596xxT1* B597xxT1* B598xxT1* Class	1						
Contact	Ronner Christoph			Important remai	Important remarks:			
Division Address	8530 Deutschlandsberg, AUSTRIA product Tel: mailto: L43 2462 900 2120 filmrtional not-enom db/@tritkelectronics tdk.com				roduct parts, substances etc. that are below a percentage of 0.1 % by weight, if not otherwise egulated.) This Material Data Sheet contains typical values of the respective products set forth			
*) others: .(not declarable or prohibited substances acc. GADSL) **) typical mass percentage of substance +) listed in the Candidate list of Substances of Very High Concern acc. to Regulation 1907/2006/EC				best present kno specifications, ur AFFILIATES HEI WHETHER EXP AND VALUES C	herein. We expressly point out that all values and statements contained herein are based on or best present knowledge and cannot be regarded as binding statements or binding product specifications, unless otherwise explicitly agreed in writing. TDK ELECTRONICS AG AND ITS AFFILIATES HEREBY EXPRESSLY DISCLAIM ANY REPRESENTATION OR WARRANTY, WHETHER EXPRESS, IMPLIED OR STATUTORY, WITH REGARD TO THE STATEMENTS AND VALUES CONTAINED HEREIN, INCLUDING BUT NOT LIMITED TO ANY REPRESENTATION OR WARRANTY OF MERCHANTABILITY OR SUITABILITY FOR ANY PURPOSE.			
of the European Parlian	nent and of the Council	of June 8 th , 2011 on th	e restriction of the use of co	are compatible with the re- ertain hazardous substanc	quirements according to Art. 4 es in electrical and electronic e		Directive 2011/65/EU	
□ no exemptions; □ Exemption 6 (a): □ Exemption 6 (b): □ Exemption 6 (c): □ Exemption 7 (a):	ead as an alloying element ad as an alloying element opper alloy containing up to ead in high melting tempera	in steel for machining purpo in aluminium containing up t 4 % lead by weight; ture type solder (i.e. lead-ba	used alloys containing 85 % by v	aining up to 0,35 % lead by we veight or more lead);	eight; .g. piezoelectronic devices, or in a g	lace of common matrix composition	4.	

- Exemption 7 (c)-III: Lead in dielectric ceramic in capacitors for a rated voltage of less than 125 V AC or 250 V DC;
 Exemption 15: Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages;
 Other Exemption than above